



**THE DATASHEET OF
SM72501MFX/NOPB**



SM72501 SolarMagic Precision, CMOS Input, RRIO, Wide Supply Range Amplifier

Check for Samples: [SM72501](#)

FEATURES

- Renewable Energy Grade
Unless Otherwise noted, Typical values at $V_S = 5V$
- Input Offset Voltage $\pm 200 \mu V$ (max)
- Input Bias Current $\pm 200 fA$
- Input Voltage Noise $9 nV/\sqrt{Hz}$
- CMRR 130 dB
- Open Loop Gain 130 dB
- Temperature Range $-40^\circ C$ to $125^\circ C$
- Unity Gain Bandwidth 2.5 MHz
- Supply Current (SM72501) $715 \mu A$
- Supply Voltage Range 2.7V to 12V
- Rail-to-rail Input and Output

APPLICATIONS

- High Impedance Sensor Interface
- Battery Powered Instrumentation
- High Gain Amplifiers
- DAC Buffer
- Instrumentation Amplifier
- Active Filters

DESCRIPTION

The SM72501 is a low offset voltage, rail-to-rail input and output precision amplifier with a CMOS input stage and a wide supply voltage range. The SM72501 is ideal for sensor interface and other instrumentation applications.

The low offset voltage of less than $\pm 200 \mu V$ along with the low input bias current of less than $\pm 1 pA$ makes the SM72501 ideal for precision applications. The SM72501 is built utilizing VIP50 technology, which allows the combination of a CMOS input stage and a 12V common mode and supply voltage range. This makes the SM72501 a great choice in many applications where conventional CMOS parts cannot operate under the desired voltage conditions.

The SM72501 has a rail-to-rail input stage that significantly reduces the CMRR glitch commonly associated with rail-to-rail input amplifiers. This is achieved by trimming both sides of the complimentary input stage, thereby reducing the difference between the NMOS and PMOS offsets. The output of the SM72501 swings within 40 mV of either rail to maximize the signal dynamic range in applications requiring low supply voltage.

The SM72501 is offered in the space saving 5-Pin SOT-23. This small package is an ideal solution for area constrained PC boards and portable electronics.

Typical Application

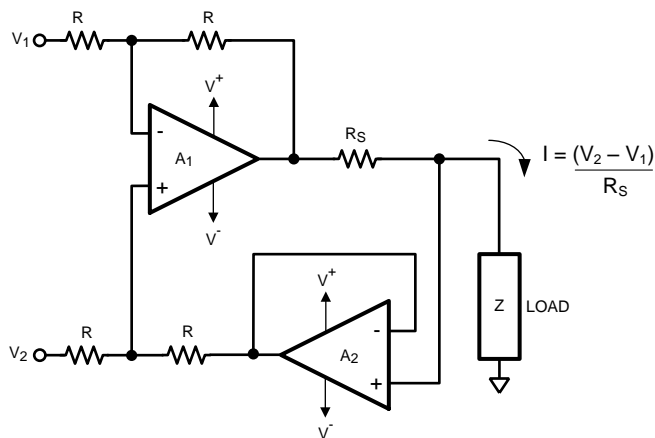


Figure 1. Precision Current Source



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾⁽²⁾

ESD Tolerance ⁽³⁾	Human Body Model	2000V
	Machine Model	200V
Charge-Device Model		1000V
V_{IN} Differential		±300 mV
Supply Voltage ($V_S = V^+ - V^-$)		13.2V
Voltage at Input/Output Pins		$V^+ + 0.3V, V^- - 0.3V$
Input Current		10 mA
Storage Temperature Range		-65°C to +150°C
Junction Temperature ⁽⁴⁾		+150°C
Soldering Information	Infrared or Convection (20 sec)	235°C
	Wave Soldering Lead Temp. (10 sec)	260°C

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional. For specifications and the test conditions, see the Electrical Characteristics Tables.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) Human Body Model, applicable std. MIL-STD-883, Method 3015.7. Machine Model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC) Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC).
- (4) The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA} . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / \theta_{JA}$. All numbers apply for packages soldered directly onto a PC Board.

Operating Ratings⁽¹⁾

Temperature Range ⁽²⁾		-40°C to +125°C
Supply Voltage ($V_S = V^+ - V^-$)		2.7V to 12V
Package Thermal Resistance (θ_{JA}) ⁽²⁾	5-Pin SOT-23	265°C/W

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional. For specifications and the test conditions, see the Electrical Characteristics Tables.
- (2) The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA} . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / \theta_{JA}$. All numbers apply for packages soldered directly onto a PC Board.

3V Electrical Characteristics⁽¹⁾

Unless otherwise specified, all limits are specified for $T_A = 25^\circ\text{C}$, $V^+ = 3\text{V}$, $V^- = 0\text{V}$, $V_{\text{CM}} = V^+/2$, and $R_L > 10\text{ k}\Omega$ to $V^+/2$.

Boldface limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min ⁽²⁾	Typ ⁽³⁾	Max ⁽²⁾	Units
V_{OS}	Input Offset Voltage			±37	±200 ±500	μV
TCV_{OS}	Input Offset Voltage Temperature Drift	See ⁽⁴⁾		±1	±5	μV/°C
I_{B}	Input Bias Current	See ⁽⁴⁾⁽⁵⁾ -40°C ≤ T_A ≤ 85°C		±0.2	±1 ±50	pA
		See ⁽⁴⁾⁽⁵⁾ -40°C ≤ T_A ≤ 125°C		±0.2	±1 ±400	
I_{OS}	Input Offset Current			40		fA
CMRR	Common Mode Rejection Ratio	$0\text{V} \leq V_{\text{CM}} \leq 3\text{V}$	86 80	130		dB
PSRR	Power Supply Rejection Ratio	$2.7\text{V} \leq V^+ \leq 12\text{V}$, $V_O = V^+/2$	86 82	98		dB
CMVR	Common Mode Voltage Range	CMRR ≥ 80 dB CMRR ≥ 77 dB	-0.2 -0.2		3.2 3.2	V
A_{VOL}	Open Loop Voltage Gain	$R_L = 2\text{ k}\Omega$ $V_O = 0.3\text{V}$ to 2.7V	100 96	114		dB
		$R_L = 10\text{ k}\Omega$ $V_O = 0.2\text{V}$ to 2.8V	100 96	124		
V_{OUT}	Output Voltage Swing High	$R_L = 2\text{ k}\Omega$ to $V^+/2$		40	80 120	mV from V^+
		$R_L = 10\text{ k}\Omega$ to $V^+/2$		30	40 60	
	Output Voltage Swing Low	$R_L = 2\text{ k}\Omega$ to $V^+/2$		40	60 80	mV
		$R_L = 10\text{ k}\Omega$ to $V^+/2$		20	40 50	
I_{OUT}	Output Current ⁽⁶⁾⁽⁷⁾	Sourcing $V_O = V^+/2$ $V_{\text{IN}} = 100\text{ mV}$	25 15	42		mA
		Sinking $V_O = V^+/2$ $V_{\text{IN}} = -100\text{ mV}$	25 20	42		
I_{S}	Supply Current			0.670	1.0 1.2	mA
SR	Slew Rate ⁽⁸⁾	$A_V = +1$, $V_O = 2\text{ V}_{\text{PP}}$ 10% to 90%		0.9		V/μs
GBW	Gain Bandwidth			2.5		MHz
THD+N	Total Harmonic Distortion + Noise	$f = 1\text{ kHz}$, $A_V = 1$, $R_{\text{L}} = 10\text{ k}\Omega$		0.02		%
e_{n}	Input Referred Voltage Noise Density	$f = 1\text{ kHz}$		9		nV/√Hz
i_{n}	Input Referred Current Noise Density	$f = 100\text{ kHz}$		1		fA/√Hz

- (1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that $T_J = T_A$. Parametric performance is indicated in the electrical tables under conditions of internal self-heating where $T_J > T_A$.
- (2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are specified through correlations using the Statistical Quality Control (SQC) method.
- (3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested on shipped production material.
- (4) This parameter is specified by design and/or characterization and is not tested in production.
- (5) Positive current corresponds to current flowing into the device.
- (6) The maximum power dissipation is a function of $T_{\text{J(MAX)}}$, θ_{JA} . The maximum allowable power dissipation at any ambient temperature is $P_{\text{D}} = (T_{\text{J(MAX)}} - T_{\text{A}}) / \theta_{\text{JA}}$. All numbers apply for packages soldered directly onto a PC Board.
- (7) The short circuit test is a momentary test.
- (8) The number specified is the slower of positive and negative slew rates.

5V Electrical Characteristics⁽¹⁾

Unless otherwise specified, all limits are specified for $T_A = 25^\circ\text{C}$, $V^+ = 5\text{V}$, $V^- = 0\text{V}$, $V_{\text{CM}} = V^+/2$, and $R_L > 10\text{ k}\Omega$ to $V^+/2$.

Boldface limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min ⁽²⁾	Typ ⁽³⁾	Max ⁽²⁾	Units
V_{OS}	Input Offset Voltage			± 37	± 200 ± 500	μV
TCV_{OS}	Input Offset Voltage Temperature Drift	See ⁽⁴⁾		± 1	± 5	$\mu\text{V}/^\circ\text{C}$
I_{B}	Input Bias Current	See ⁽⁴⁾⁽⁵⁾ $-40^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$		± 0.2	± 1 ± 50	pA
		See ⁽⁴⁾⁽⁵⁾ $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$		± 0.2	± 1 ± 400	
I_{OS}	Input Offset Current			40		fA
CMRR	Common Mode Rejection Ratio	$0\text{V} \leq V_{\text{CM}} \leq 5\text{V}$	88 83	130		dB
PSRR	Power Supply Rejection Ratio	$2.7\text{V} \leq V^+ \leq 12\text{V}$, $V_{\text{O}} = V^+/2$	86 82	100		dB
CMVR	Common Mode Voltage Range	CMRR $\geq 80\text{ dB}$ CMRR $\geq 78\text{ dB}$	-0.2 -0.2		5.2 5.2	V
A_{VOL}	Open Loop Voltage Gain	$R_L = 2\text{ k}\Omega$ $V_{\text{O}} = 0.3\text{V to } 4.7\text{V}$	100 96	119		dB
		$R_L = 10\text{ k}\Omega$ $V_{\text{O}} = 0.2\text{V to } 4.8\text{V}$	100 96	130		
V_{OUT}	Output Voltage Swing High	$R_L = 2\text{ k}\Omega$ to $V^+/2$		60	110 130	mV from V^+
		$R_L = 10\text{ k}\Omega$ to $V^+/2$		40	50 70	
	Output Voltage Swing Low	$R_L = 2\text{ k}\Omega$ to $V^+/2$		50	80 90	mV
		$R_L = 10\text{ k}\Omega$ to $V^+/2$		30	40 50	
I_{OUT}	Output Current ⁽⁶⁾⁽⁷⁾	Sourcing $V_{\text{O}} = V^+/2$ $V_{\text{IN}} = 100\text{ mV}$	40 28	66		mA
		Sinking $V_{\text{O}} = V^+/2$ $V_{\text{IN}} = -100\text{ mV}$	40 28	76		
I_{S}	Supply Current			0.715	1.0 1.2	mA
SR	Slew Rate ⁽⁸⁾	$A_V = +1$, $V_{\text{O}} = 4\text{ V}_{\text{PP}}$ 10% to 90%		1.0		$\text{V}/\mu\text{s}$
GBW	Gain Bandwidth			2.5		MHz
THD+N	Total Harmonic Distortion + Noise	$f = 1\text{ kHz}$, $A_V = 1$, $R_L = 10\text{ k}\Omega$		0.02		%
e_{n}	Input Referred Voltage Noise Density	$f = 1\text{ kHz}$		9		$\text{nV}/\sqrt{\text{Hz}}$
i_{n}	Input Referred Current Noise Density	$f = 100\text{ kHz}$		1		$\text{fA}/\sqrt{\text{Hz}}$

- (1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that $T_J = T_A$. Parametric performance is indicated in the electrical tables under conditions of internal self-heating where $T_J > T_A$.
- (2) Limits are 100% production tested at 25°C . Limits over the operating temperature range are specified through correlations using the Statistical Quality Control (SQC) method.
- (3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested on shipped production material.
- (4) This parameter is specified by design and/or characterization and is not tested in production.
- (5) Positive current corresponds to current flowing into the device.
- (6) The maximum power dissipation is a function of $T_{\text{J(MAX)}}$, θ_{JA} . The maximum allowable power dissipation at any ambient temperature is $P_{\text{D}} = (T_{\text{J(MAX)}} - T_{\text{A}}) / \theta_{\text{JA}}$. All numbers apply for packages soldered directly onto a PC Board.
- (7) The short circuit test is a momentary test.
- (8) The number specified is the slower of positive and negative slew rates.

±5V Electrical Characteristics⁽¹⁾

Unless otherwise specified, all limits are specified for $T_A = 25^\circ\text{C}$, $V^+ = 5\text{V}$, $V^- = -5\text{V}$, $V_{\text{CM}} = 0\text{V}$, and $R_L > 10\text{ k}\Omega$ to 0V .

Boldface limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min ⁽²⁾	Typ ⁽³⁾	Max ⁽²⁾	Units
V_{OS}	Input Offset Voltage			±37	±200 ±500	μV
TCV_{OS}	Input Offset Voltage Temperature Drift	See ⁽⁴⁾		±1	±5	μV/°C
I_{B}	Input Bias Current	See ⁽⁴⁾⁽⁵⁾ -40°C ≤ T_A ≤ 85°C		±0.2	1 ±50	pA
		See ⁽⁴⁾⁽⁵⁾ -40°C ≤ T_A ≤ 125°C		±0.2	1 ±400	
I_{OS}	Input Offset Current			40		fA
CMRR	Common Mode Rejection Ratio	-5V ≤ V_{CM} ≤ 5V	92 88	138		dB
PSRR	Power Supply Rejection Ratio	2.7V ≤ V^+ ≤ 12V, $V_{\text{O}} = 0\text{V}$	86 82	98		dB
CMVR	Common Mode Voltage Range	CMRR ≥ 80 dB CMRR ≥ 78 dB	-5.2 -5.2		5.2 5.2	V
A_{VOL}	Open Loop Voltage Gain	$R_L = 2\text{ k}\Omega$ $V_{\text{O}} = -4.7\text{V}$ to 4.7V	100 98	121		dB
		$R_L = 10\text{ k}\Omega$ $V_{\text{O}} = -4.8\text{V}$ to 4.8V	100 98	134		
V_{OUT}	Output Voltage Swing High	$R_L = 2\text{ k}\Omega$ to 0V		90	150 170	mV from V^+
		$R_L = 10\text{ k}\Omega$ to 0V		40	80 100	
	Output Voltage Swing Low	$R_L = 2\text{ k}\Omega$ to 0V		90	130 150	mV from V^-
		$R_L = 10\text{ k}\Omega$ to 0V		40	50 60	
I_{OUT}	Output Current ⁽⁶⁾⁽⁷⁾	Sourcing $V_{\text{O}} = 0\text{V}$ $V_{\text{IN}} = 100\text{ mV}$	50 35	86		mA
		Sinking $V_{\text{O}} = 0\text{V}$ $V_{\text{IN}} = -100\text{ mV}$	50 35	84		
I_{S}	Supply Current			0.790	1.1 1.3	mA
SR	Slew Rate ⁽⁸⁾	$A_V = +1$, $V_{\text{O}} = 9\text{ V}_{\text{PP}}$ 10% to 90%		1.1		V/μs
GBW	Gain Bandwidth			2.5		MHz
THD+N	Total Harmonic Distortion + Noise	$f = 1\text{ kHz}$, $A_V = 1$, $R_L = 10\text{ k}\Omega$		0.02		%
e_n	Input Referred Voltage Noise Density	$f = 1\text{ kHz}$		9		nV/√Hz
i_n	Input Referred Current Noise Density	$f = 100\text{ kHz}$		1		fA/√Hz

- (1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that $T_J = T_A$. Parametric performance is indicated in the electrical tables under conditions of internal self-heating where $T_J > T_A$.
- (2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are specified through correlations using the Statistical Quality Control (SQC) method.
- (3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested on shipped production material.
- (4) This parameter is specified by design and/or characterization and is not tested in production.
- (5) Positive current corresponds to current flowing into the device.
- (6) The maximum power dissipation is a function of $T_{\text{J(MAX)}}$, θ_{JA} . The maximum allowable power dissipation at any ambient temperature is $P_{\text{D}} = (T_{\text{J(MAX)}} - T_{\text{A}}) / \theta_{\text{JA}}$. All numbers apply for packages soldered directly onto a PC Board.
- (7) The short circuit test is a momentary test.
- (8) The number specified is the slower of positive and negative slew rates.

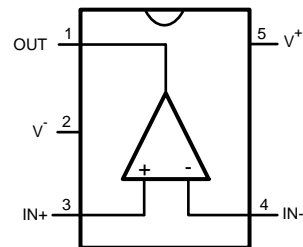
Connection Diagram

Figure 2. 5-Pin SOT-23 - Top View
See DBV Package

Typical Performance Characteristics

Unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_{CM} = V_S/2$, $R_L > 10\text{ k}\Omega$.

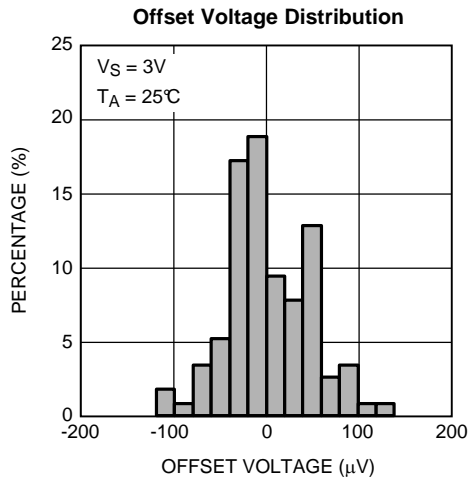


Figure 3.

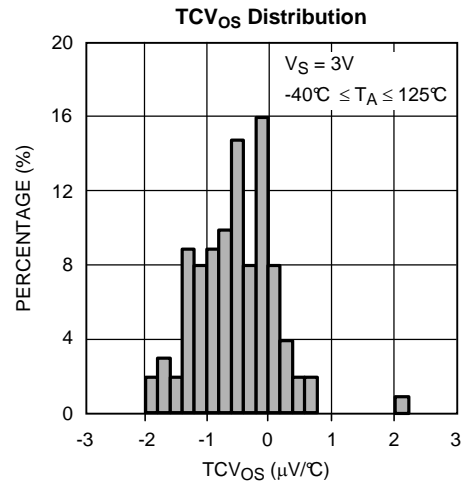


Figure 4.

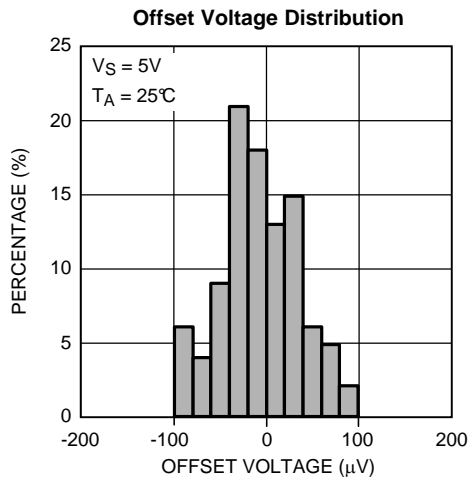


Figure 5.

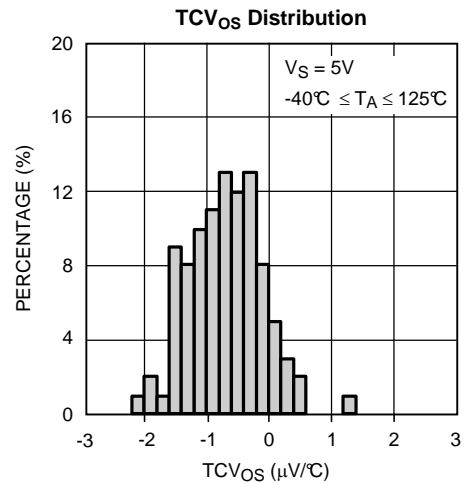


Figure 6.

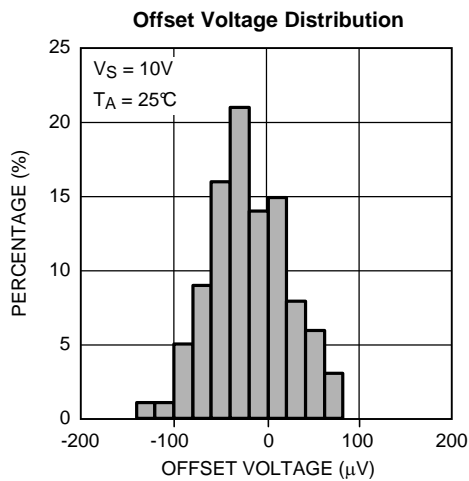


Figure 7.

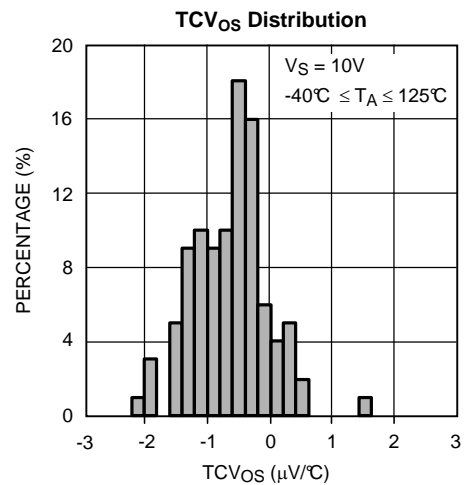


Figure 8.

Typical Performance Characteristics (continued)

Unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_{CM} = V_S/2$, $R_L > 10\text{ k}\Omega$.

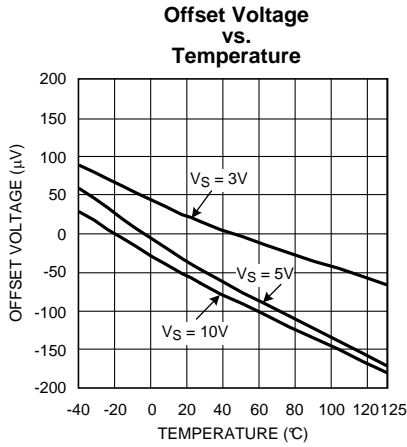


Figure 9.

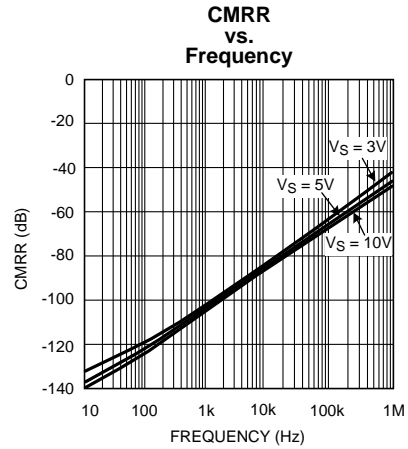


Figure 10.

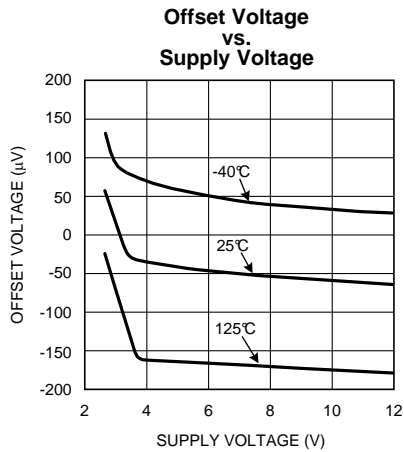


Figure 11.

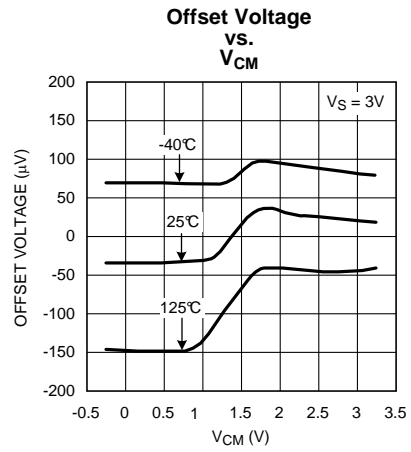


Figure 12.

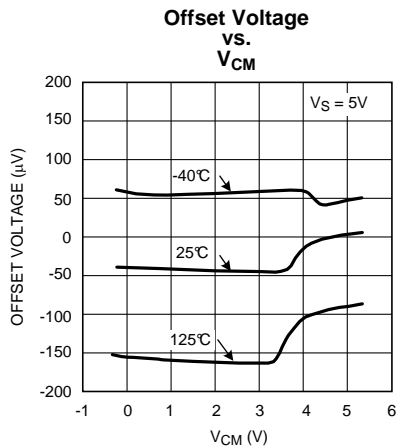


Figure 13.

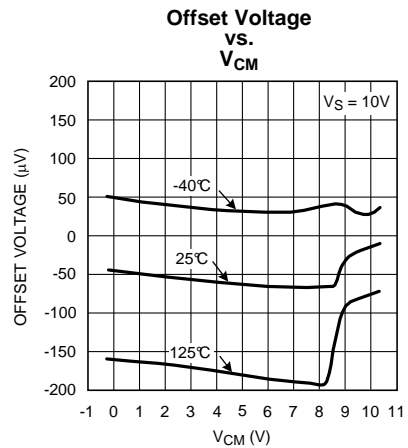


Figure 14.

Typical Performance Characteristics (continued)

Unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_{CM} = V_S/2$, $R_L > 10\text{ k}\Omega$.

Input Bias Current vs. V_{CM}

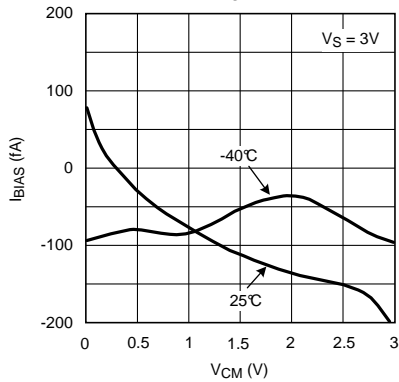


Figure 15.

Input Bias Current vs. V_{CM}

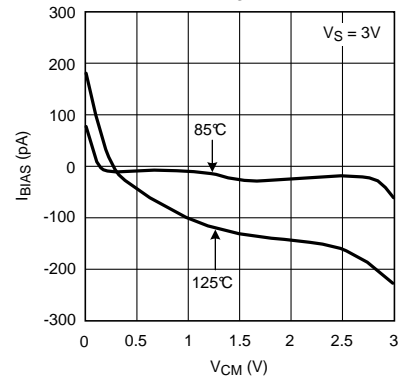


Figure 16.

Input Bias Current vs. V_{CM}

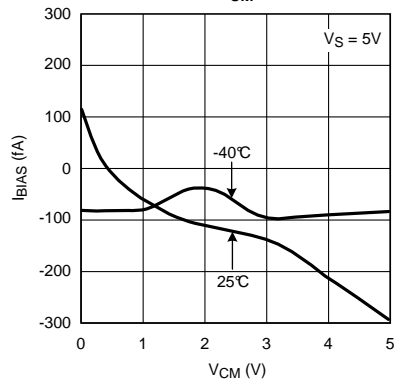


Figure 17.

Input Bias Current vs. V_{CM}

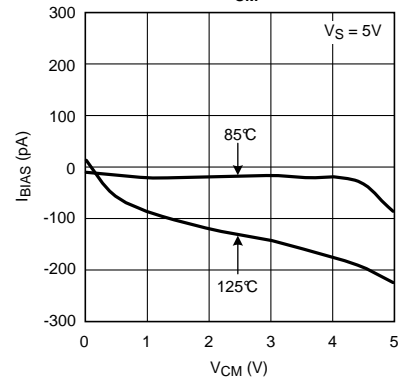


Figure 18.

Input Bias Current vs. V_{CM}

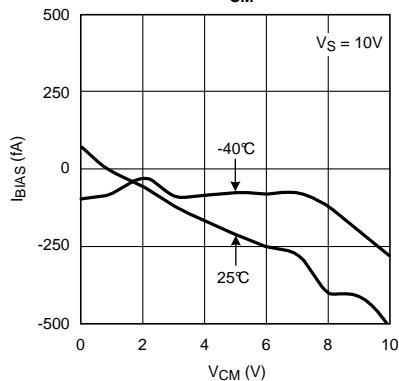


Figure 19.

Input Bias Current vs. V_{CM}

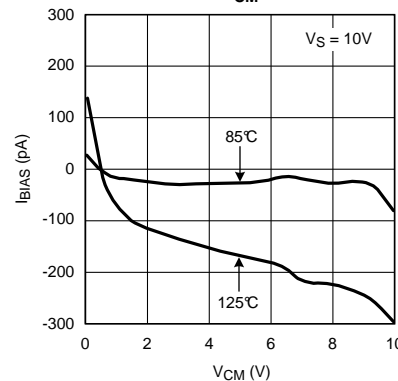


Figure 20.

Typical Performance Characteristics (continued)

Unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_{CM} = V_S/2$, $R_L > 10\text{ k}\Omega$.

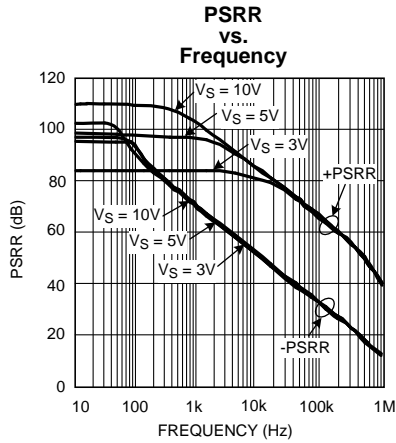


Figure 21.

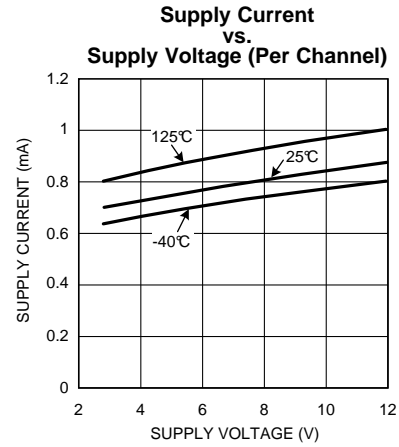


Figure 22.

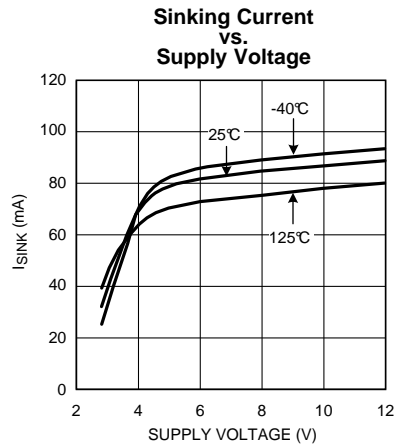


Figure 23.

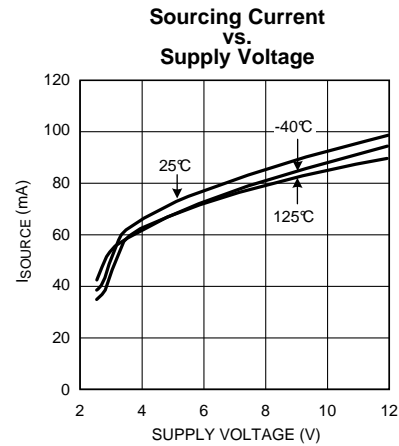


Figure 24.

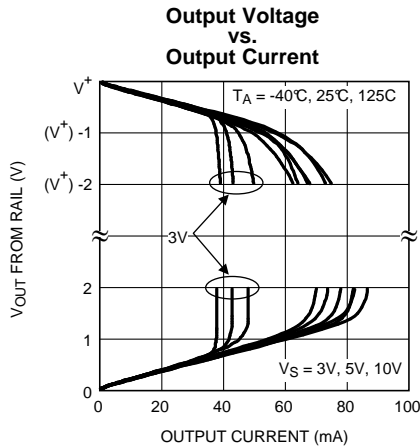


Figure 25.

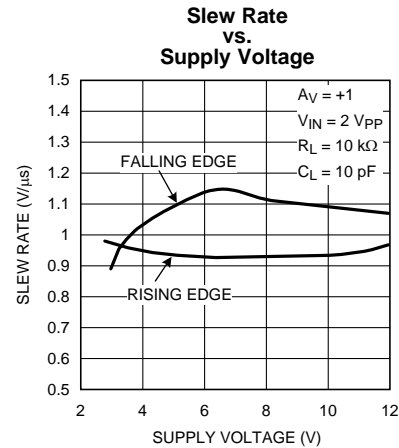


Figure 26.

Typical Performance Characteristics (continued)

Unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_{CM} = V_S/2$, $R_L > 10\text{ k}\Omega$.

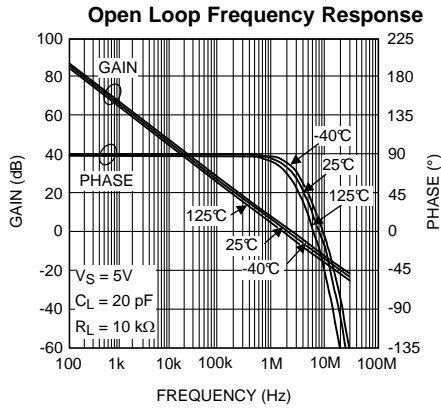


Figure 27.

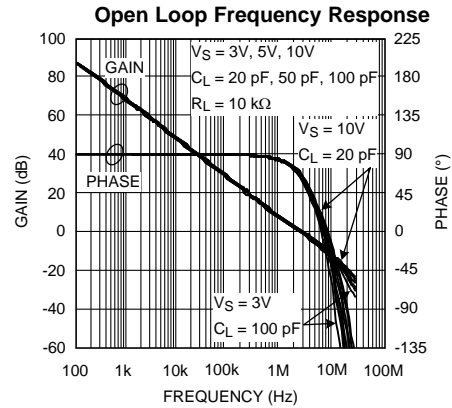


Figure 28.

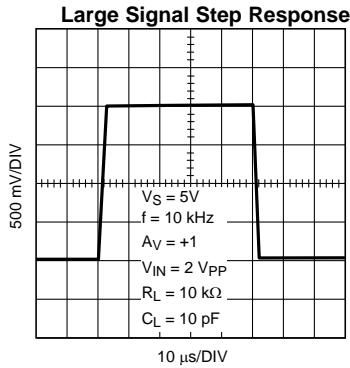


Figure 29.

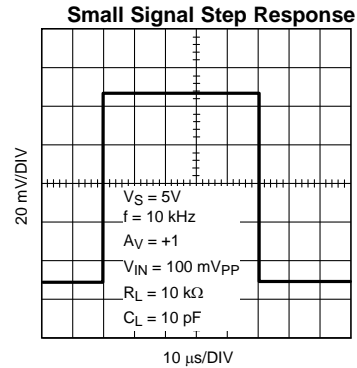


Figure 30.

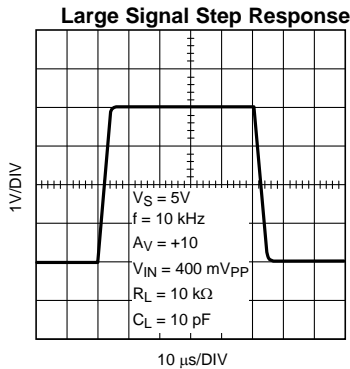


Figure 31.

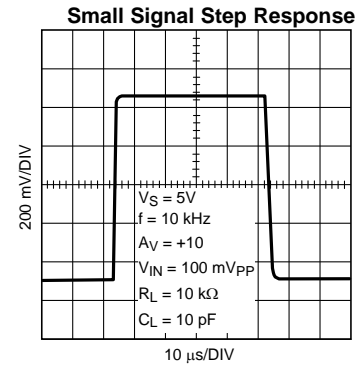


Figure 32.

Typical Performance Characteristics (continued)

Unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_{CM} = V_S/2$, $R_L > 10\text{ k}\Omega$.

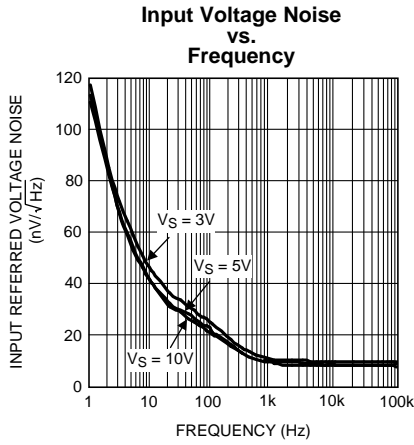


Figure 33.

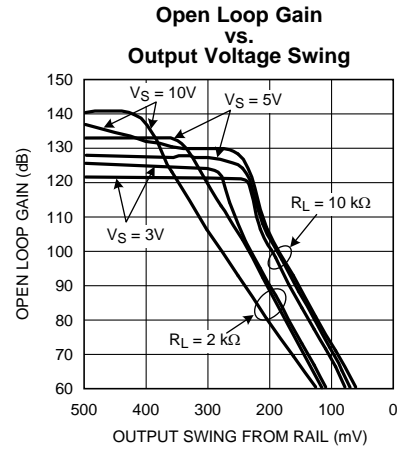


Figure 34.

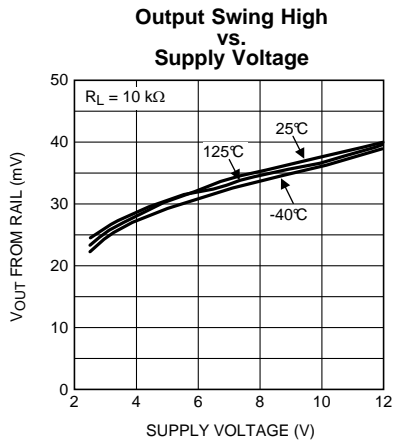


Figure 35.

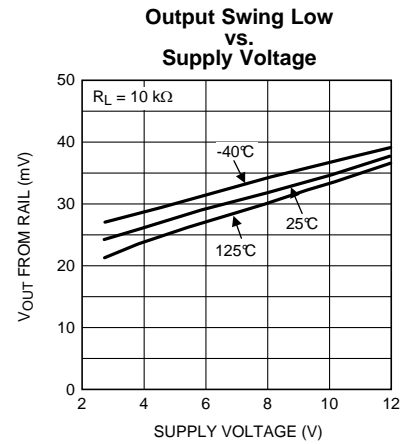


Figure 36.

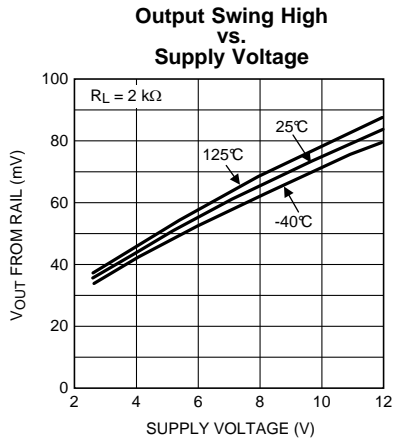


Figure 37.

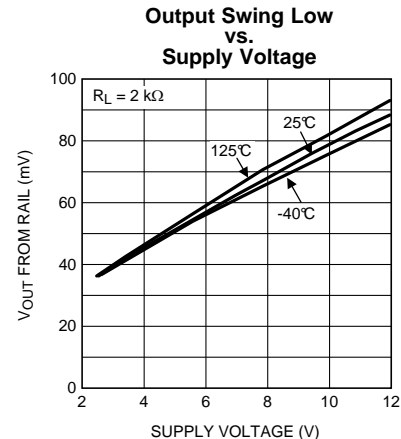
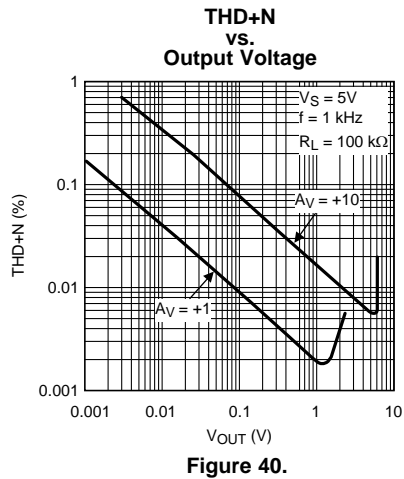
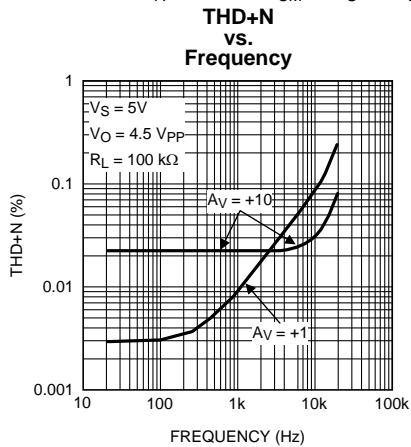


Figure 38.

Typical Performance Characteristics (continued)

Unless otherwise noted: $T_A = 25^\circ\text{C}$, $V_{CM} = V_S/2$, $R_L > 10\text{ k}\Omega$.



APPLICATION INFORMATION

SM72501

The SM72501 is a low offset voltage, rail-to-rail input and output precision amplifier with a CMOS input stage and wide supply voltage range of 2.7V to 12V. The SM72501 has a very low input bias current of only ± 200 fA at room temperature.

The wide supply voltage range of 2.7V to 12V over the extensive temperature range of -40°C to 125°C makes the SM72501 an excellent choice for low voltage precision applications with extensive temperature requirements.

The SM72501 has only ± 37 μV of typical input referred offset voltage and this offset is specified to be less than ± 500 μV over temperature. This minimal offset voltage allows more accurate signal detection and amplification in precision applications.

The low input bias current of only ± 200 fA along with the low input referred voltage noise of 9 $\text{nV}/\sqrt{\text{Hz}}$ gives the SM72501 superiority for use in sensor applications. Lower levels of noise from the SM72501 means better signal fidelity and a higher signal-to-noise ratio.

Technical support and extensive characterization data is available for sensitive applications or applications with a constrained error budget.

The SM72501 is offered in the space saving 5-Pin SOT-23. This small package is an ideal solution for area constrained PC boards and portable electronics.

CAPACITIVE LOAD

The SM72501 can be connected as a non-inverting unity gain follower. This configuration is the most sensitive to capacitive loading.

The combination of a capacitive load placed on the output of an amplifier along with the amplifier's output impedance creates a phase lag which in turn reduces the phase margin of the amplifier. If the phase margin is significantly reduced, the response will be either underdamped or it will oscillate.

In order to drive heavier capacitive loads, an isolation resistor, R_{ISO} , in [Figure 41](#) should be used. By using this isolation resistor, the capacitive load is isolated from the amplifier's output, and hence, the pole caused by C_L is no longer in the feedback loop. The larger the value of R_{ISO} , the more stable the output voltage will be. If values of R_{ISO} are sufficiently large, the feedback loop will be stable, independent of the value of C_L . However, larger values of R_{ISO} result in reduced output swing and reduced output current drive.

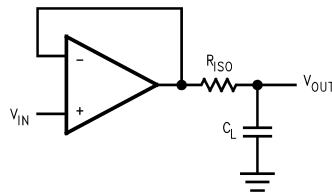


Figure 41. Isolating Capacitive Load

INPUT CAPACITANCE

CMOS input stages inherently have low input bias current and higher input referred voltage noise. The SM72501 enhances this performance by having the low input bias current of only ± 200 fA, as well as, a very low input referred voltage noise of 9 $\text{nV}/\sqrt{\text{Hz}}$. In order to achieve this a larger input stage has been used. This larger input stage increases the input capacitance of the SM72501. The typical value of this input capacitance, C_{IN} , for the SM72501 is 25 pF. The input capacitance will interact with other impedances such as gain and feedback resistors, which are seen on the inputs of the amplifier, to form a pole. This pole will have little or no effect on the output of the amplifier at low frequencies and DC conditions, but will play a bigger role as the frequency increases. At higher frequencies, the presence of this pole will decrease phase margin and will also cause gain peaking. In order to compensate for the input capacitance, care must be taken in choosing the feedback resistors. In addition to being selective in picking values for the feedback resistor, a capacitor can be added to the feedback path to increase stability.

The DC gain of the circuit shown in [Figure 42](#) is simply $-R_2/R_1$.

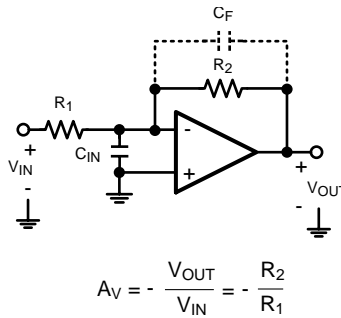


Figure 42. Compensating for Input Capacitance

For the time being, ignore C_F . The AC gain of the circuit in Figure 42 can be calculated as follows:

$$\frac{V_{OUT}}{V_{IN}}(s) = \frac{-R_2/R_1}{\left[1 + \frac{s}{\left(\frac{A_0 R_1}{R_1 + R_2} \right)} + \frac{s^2}{\left(\frac{A_0}{C_{IN} R_2} \right)} \right]} \quad (1)$$

This equation is rearranged to find the location of the two poles:

$$P_{1,2} = \frac{-1}{2C_{IN}} \left[\frac{1}{R_1} + \frac{1}{R_2} \pm \sqrt{\left(\frac{1}{R_1} + \frac{1}{R_2} \right)^2 - \frac{4 A_0 C_{IN}}{R_2}} \right] \quad (2)$$

As shown in Equation 2, as values of R_1 and R_2 are increased, the magnitude of the poles is reduced, which in turn decreases the bandwidth of the amplifier. Whenever possible, it is best to choose smaller feedback resistors. Figure 43 shows the effect of the feedback resistor on the bandwidth of the SM72501.

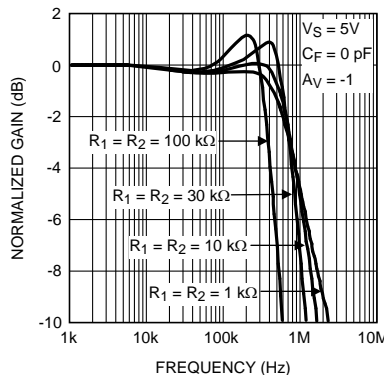


Figure 43. Closed Loop Gain vs. Frequency

Equation 2 has two poles. In most cases, it is the presence of pairs of poles that causes gain peaking. In order to eliminate this effect, the poles should be placed in Butterworth position, since poles in Butterworth position do not cause gain peaking. To achieve a Butterworth pair, the quantity under the square root in Equation 2 should be set to equal -1 . Using this fact and the relation between R_1 and R_2 , $R_2 = -A_V R_1$, the optimum value for R_1 can be found. This is shown in Equation 3. If R_1 is chosen to be larger than this optimum value, gain peaking will occur.

$$R_1 < \frac{(1 - A_V)^2}{2A_0 A_V C_{IN}} \quad (3)$$

In Figure 42, C_F is added to compensate for input capacitance and to increase stability. Additionally, C_F reduces or eliminates the gain peaking that can be caused by having a larger feedback resistor. Figure 44 shows how C_F reduces gain peaking.

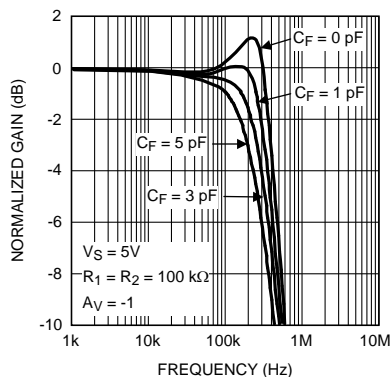


Figure 44. Closed Loop Gain vs. Frequency with Compensation

DIODES BETWEEN THE INPUTS

The SM72501 has a set of anti-parallel diodes between the input pins, as shown in [Figure 45](#). These diodes are present to protect the input stage of the amplifier. At the same time, they limit the amount of differential input voltage that is allowed on the input pins. A differential signal larger than one diode voltage drop might damage the diodes. The differential signal between the inputs needs to be limited to ± 300 mV or the input current needs to be limited to ± 10 mA.

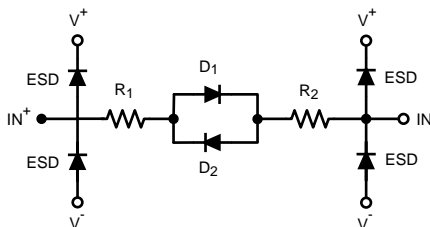


Figure 45. Input of SM72501

PRECISION CURRENT SOURCE

The SM72501 can be used as a precision current source in many different applications. [Figure 46](#) shows a typical precision current source. This circuit implements a precision voltage controlled current source. Amplifier A1 is a differential amplifier that uses the voltage drop across R_S as the feedback signal. Amplifier A2 is a buffer that eliminates the error current from the load side of the R_S resistor that would flow in the feedback resistor if it were connected to the load side of the R_S resistor. In general, the circuit is stable as long as the closed loop bandwidth of amplifier A2 is greater than the closed loop bandwidth of amplifier A1. Note that if A1 and A2 are the same type of amplifiers, then the feedback around A1 will reduce its bandwidth compared to A2.

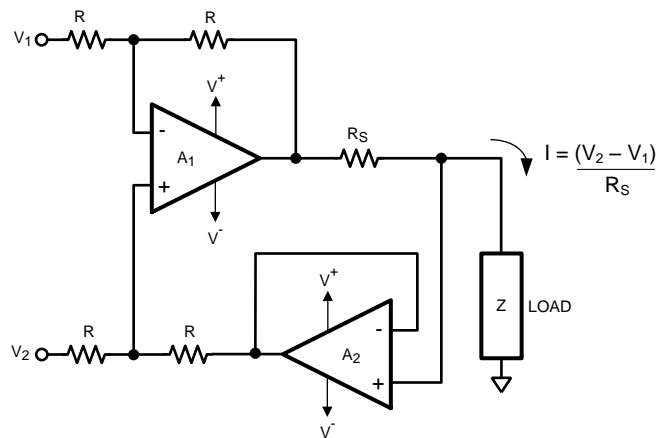


Figure 46. Precision Current Source

The equation for output current can be derived as follows:

$$\frac{V_2 R}{R + R} + \frac{(V_0 - I R_S) R}{R + R} = \frac{V_1 R}{R + R} + \frac{V_0 R}{R + R} \quad (4)$$

Solving for the current I results in the following equation:

$$I = \frac{V_2 - V_1}{R_S} \quad (5)$$

LOW INPUT VOLTAGE NOISE

The SM72501 has a very low input voltage noise of $9 \text{ nV}/\sqrt{\text{Hz}}$. This input voltage noise can be further reduced by placing N amplifiers in parallel as shown in Figure 47. The total voltage noise on the output of this circuit is divided by the square root of the number of amplifiers used in this parallel combination. This is because each individual amplifier acts as an independent noise source, and the average noise of independent sources is the quadrature sum of the independent sources divided by the number of sources. For N identical amplifiers, this means:

$$\begin{aligned} \text{REDUCED INPUT VOLTAGE NOISE} &= \frac{1}{N} \sqrt{e_{n1}^2 + e_{n2}^2 + \dots + e_{nN}^2} \\ &= \frac{1}{N} \sqrt{N e_n^2} = \frac{\sqrt{N}}{N} e_n \\ &= \frac{1}{\sqrt{N}} e_n \end{aligned} \quad (6)$$

Figure 47 shows a schematic of this input voltage noise reduction circuit. Typical resistor values are:

$R_G = 10\Omega$, $R_F = 1 \text{ k}\Omega$, and $R_O = 1 \text{ k}\Omega$.

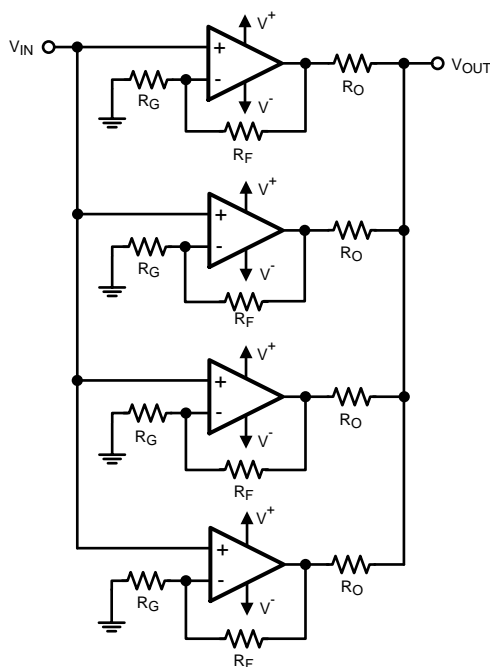


Figure 47. Noise Reduction Circuit

TOTAL NOISE CONTRIBUTION

The SM72501 has very low input bias current, very low input current noise, and very low input voltage noise. As a result, these amplifiers are ideal choices for circuits with high impedance sensor applications.

Figure 48 shows the typical input noise of the SM72501 as a function of source resistance where:

e_n denotes the input referred voltage noise

e_i is the voltage drop across source resistance due to input referred current noise or $e_i = R_S * i_n$

e_t shows the thermal noise of the source resistance

e_{ni} shows the total noise on the input.

Where:

$$e_{ni} = \sqrt{e_n^2 + e_i^2 + e_t^2} \quad (7)$$

The input current noise of the SM72501 is so low that it will not become the dominant factor in the total noise unless source resistance exceeds 300 M Ω , which is an unrealistically high value.

As is evident in Figure 48, at lower R_S values, total noise is dominated by the amplifier's input voltage noise. Once R_S is larger than a few kilo-Ohms, then the dominant noise factor becomes the thermal noise of R_S . As mentioned before, the current noise will not be the dominant noise factor for any practical application.

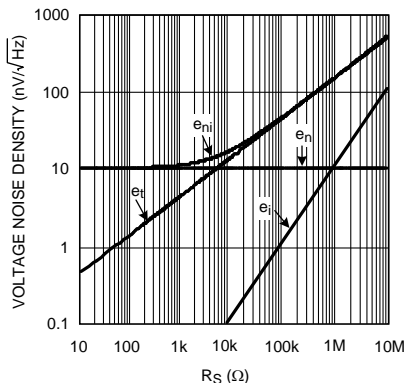


Figure 48. Total Input Noise

HIGH IMPEDANCE SENSOR INTERFACE

Many sensors have high source impedances that may range up to 10 MΩ. The output signal of sensors often needs to be amplified or otherwise conditioned by means of an amplifier. The input bias current of this amplifier can load the sensor's output and cause a voltage drop across the source resistance as shown in Figure 49, where $V_{IN+} = V_S - I_{BIAS} * R_S$

The last term, $I_{BIAS} * R_S$, shows the voltage drop across R_S . To prevent errors introduced to the system due to this voltage, an op amp with very low input bias current must be used with high impedance sensors. This is to keep the error contribution by $I_{BIAS} * R_S$ less than the input voltage noise of the amplifier, so that it will not become the dominant noise factor.

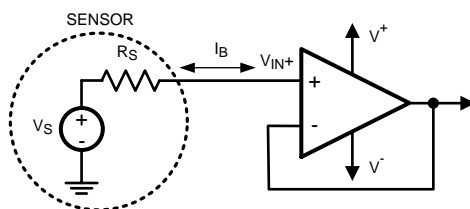


Figure 49. Noise Due to I_{BIAS}

pH electrodes are very high impedance sensors. As their name indicates, they are used to measure the pH of a solution. They usually do this by generating an output voltage which is proportional to the pH of the solution. pH electrodes are calibrated so that they have zero output for a neutral solution, pH = 7, and positive and negative voltages for acidic or alkaline solutions. This means that the output of a pH electrode is bipolar and has to be level shifted to be used in a single supply system. The rate of change of this voltage is usually shown in mV/pH and is different for different pH sensors. Temperature is also an important factor in a pH electrode reading. The output voltage of the sensor will change with temperature.

Figure 50 shows a typical output voltage spectrum of a pH electrode. Note that the exact values of output voltage will be different for different sensors. In this example, the pH electrode has an output voltage of 59.15 mV/pH at 25°C.

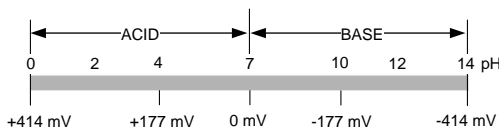


Figure 50. Output Voltage of a pH Electrode

The temperature dependence of a typical pH electrode is shown in Figure 51. As is evident, the output voltage changes with changes in temperature.

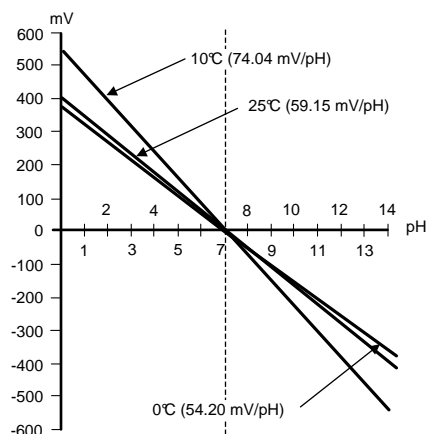


Figure 51. Temperature Dependence of a pH Electrode

The schematic shown in [Figure 52](#) is a typical circuit which can be used for pH measurement. The LM35 is a precision integrated circuit temperature sensor. This sensor is differentiated from similar products because it has an output voltage linearly proportional to Celsius measurement, without the need to convert the temperature to Kelvin. The LM35 is used to measure the temperature of the solution and feeds this reading to the Analog to Digital Converter, ADC. This information is used by the ADC to calculate the temperature effects on the pH readings. The LM35 needs to have a resistor, R_T in [Figure 52](#), to $-V^+$ in order to be able to read temperatures below 0°C . R_T is not needed if temperatures are not expected to go below zero.

The output of pH electrodes is usually large enough that it does not require much amplification; however, due to the very high impedance, the output of a pH electrode needs to be buffered before it can go to an ADC. Since most ADCs are operated on single supply, the output of the pH electrode also needs to be level shifted. Amplifier A1 buffers the output of the pH electrode with a moderate gain of +2, while A2 provides the level shifting. V_{OUT} at the output of A2 is given by: $V_{\text{OUT}} = -2V_{\text{pH}} + 1.024\text{V}$.

The LM4140A is a precision, low noise, voltage reference used to provide the level shift needed. The ADC used in this application is the ADC12032 which is a 12-bit, 2 channel converter with multiplexers on the inputs and a serial output. The 12-bit ADC enables users to measure pH with an accuracy of 0.003 of a pH unit. Adequate power supply bypassing and grounding is extremely important for ADCs. Recommended bypass capacitors are shown in [Figure 52](#). It is common to share power supplies between different components in a circuit. To minimize the effects of power supply ripples caused by other components, the op amps need to have bypass capacitors on the supply pins. Using the same value capacitors as those used with the ADC are ideal. The combination of these three values of capacitors ensures that AC noise present on the power supply line is grounded and does not interfere with the amplifiers' signal.

REVISION HISTORY

Changes from Revision B (April 2013) to Revision C	Page
• Changed layout of National Data Sheet to TI format	21

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SM72501MF/NOPB	NRND	SOT-23	DBV	5	1000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 125	S501	
SM72501MFE/NOPB	NRND	SOT-23	DBV	5	250	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 125	S501	
SM72501MFX/NOPB	NRND	SOT-23	DBV	5	3000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 125	S501	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

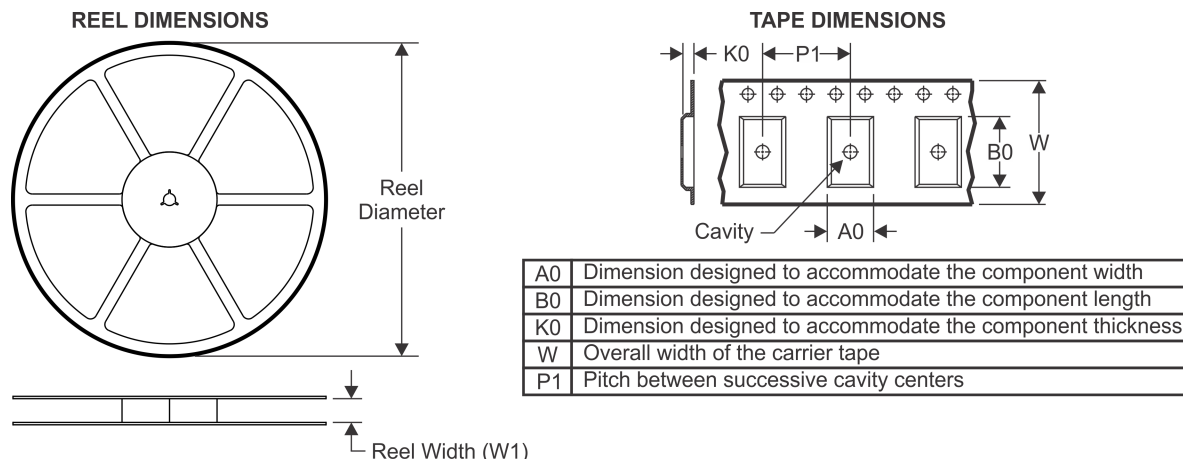
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SM72501MF/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
SM72501MFE/NOPB	SOT-23	DBV	5	250	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
SM72501MFX/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SM72501MF/NOPB	SOT-23	DBV	5	1000	208.0	191.0	35.0
SM72501MFE/NOPB	SOT-23	DBV	5	250	208.0	191.0	35.0
SM72501MFX/NOPB	SOT-23	DBV	5	3000	208.0	191.0	35.0

EXAMPLE BOARD LAYOUT

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214839/J 02/2024

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214839/J 02/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2024, Texas Instruments Incorporated

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

 [View SM72501MFX/NOPB on WIN SOURCE](#)

 [Texas Instruments](#) Information

Optimize Your Supply Chain with WIN SOURCE Solutions

-  Global Sourcing Solution
-  Obsolete Management
-  Cost Control Management
-  Shortage Management
-  Alternative Solution
-  Excess Inventory Management